

# SID

Factory: Rot am See

Article:

611

ML4

Provided:

Kracht, Enrico

Customer:

Date:

18.01.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	1	A00 B00
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	210		2	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		4	
C-RS-FR4-ML-0.20mm-105+105-TG150-HF	50201429	105	L2	5	
		200			
		105	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	210		6	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		7	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		8	
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	9	

Thickness after Pressing

B00:

890 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

990 µm

Dmin:

790 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1000 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

1100 µm

Dmin:

900 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

900 µm

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